# **Special Issue**

# Future Information & Communication Engineering 2022

# Message from the Guest Editors

This Special Issue will comprise selected papers from the ICFICE 2022, which was held at the Jeju Island in Republic of Korea on 12–14 January 2022. The URL of the ICFICE 2022 can be found below: http://icfice.org/Following ICFICE 2022, we will organise a Special Issue, soliciting original research paper with all technical aspects of computer science, information, and communication engineering. Potential topics include, but are not limited to, the following:

- Communication System and Applications
- Networking and Services
- Intelligent Information System
- Multimedia and Digital Convergence
- Semiconductor and Communication Services
- Biomedical Imaging and Engineering
- Ubiquitous Sensor Network
- Database and Internet Application
- Internet of Thing(IOT) and Big Data
- Information technology(IT) Convergence Technology

# **Guest Editors**

Prof. Dr. Yun Seop Yu

Prof. Dr. Kwang-Baek Kim

Dr. Dongsik Jo

Prof. Dr. Hee-Cheol Kim

Prof. Dr. Jeong Wook Seo

### Deadline for manuscript submissions

closed (25 March 2023)



# Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



# mdpi.com/si/113418

Applied Sciences
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
applisci@mdpi.com

mdpi.com/journal/applsci





# Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



# **About the Journal**

# Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

# Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

### **Author Benefits**

## **Open Access:**

free for readers, with article processing charges (APC) paid by authors or their institutions.

### **High Visibility:**

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, CAPlus / SciFinder, and other databases.

#### Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

